| | COUNT | DESCRIPTION OF | REVIS | SIONS | BY | CHKD | DATE | | COUN | T DES | SCRIPTI | ON OF RE | VISIONS | BY | СНК | D DA | \TE |
|---|-----------|--|---|------------------------|----------|----------|------------|-----------------|-------------------------------------|--|---|-----------------------------|---------------------------|----------------|-------|----------|---------------|
| <u> </u> | | | | | | | | | | | | | | | | | |
| APF | | L BLE STANDARD |) | | | | | | | | | | | <u> </u> | | | |
| / \ldots 1 | LIO, (L | Operating | | | _55°C | +0.10 | 5°C (No | +01) | | Storage | | | _10 | °C +0 - | ⊦eo°c | (Note | 3) |
| RATING RATING RATING RATING Applicable Conn Voltage | | lity | | | J C (110 | ` le | | | emperature Range torage Humidity | | -10°C to +60°C (Note3) | | | | | | |
| | | | | | | | | | | Range | | | | Note3) | ote3) | | |
| | | Applicable Connector | | | | | | | | 'urkont l | | | AWG 30 : 0.5A AWG 28 : 1A | | | | |
| | | | | | | | | | | | | | Current | AWG 22-26 : 2A | | | . 17 |
| | | Voicage | | | | | | | A T76 | \\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\ | | | | | | | |
| | | TTC 1.4 | | | TE | | PECI | FIG | AIIC | NS | | DEOLIE | | | | LOT | L |
| CO | | ITEM UCTION | | | TES | OI ME | THOD | | | | | REQUIR | EMENI | <u> </u> | | Q1 | AT |
| | | mination | Visuall | y and b | y meas | uring in | strument | <u>.</u> | | | | de la constanción | | | | 0 | 0 |
| Mark | | | | med vis | | | | | | Acco | oraing to | drawing. | | | | 0 | 0 |
| | | CAL CHARAC | | | | | | | | | | | | | | | |
| Contact Resistance Millivolt Level Method | | | 20mV MAX, 1mA (DC or 1000Hz). | | | | | | | | 30 mΩ MAX. | | | | | 0 | - |
| | | esistance | 500 V DC. | | | | | | | | 1,000 MΩ MIN. | | | | | +- | |
| | | | | | | | | | | | | | | | | 0 | _ |
| Volta | ge Proc | of | 650 V AC for 1 min. | | | | | | | No fl | No flashover or breakdown. | | | | 0 | _ | |
| ME | 2HAN | ICAL CHARAC | TEDISTICS | | | | | | | | | | | | | <u> </u> | |
| | | Operation | | | | ıd extra | ction. | | | ①Cc | ontact re | esistance: | 30mΩ MA | X | | 1 | Π |
| | | (Sn Plating) | 30 times insertion and extraction. | | | | | | | l _ | ②No damage, crack or looseness of parts. | | | | 0 | - | |
| | | | | | | | | | | | | | | | | | |
| Mech | nanical (| Operation (Au Plating) | 50 times insertion and extraction. | | | | | | | 1~ | | esistance: ; e, crack or | | | c | | _ |
| | | (Au i latilig) | | | | | | | | | damago | s, crack or | 1003011033 | or part | .3. | • | |
| Matir | ng and u | = | It take | s out ar | nd inser | ts with | a confor | nity c | onnect | l _ | | orce: 38.0 | | | | | |
| force | : | (Sn Plating) | 1 | | | | | | | ②Ex | ②Extraction Force: 1.5N MIN | | | | 0 | - | |
| Matir | ng and u | nmating | It take | s out ar | nd inser | ts with | a confor | nity c | onnect | or. (1)Ins | sertion F | orce: 29.7 | N MAX | | | | |
| force | | (Au Plating) | | | | | | • | | 1 - | | Force: 1.5 | | | | 0 | - |
| | | | | | | | | | | | | | | | | | |
| Vibra | tion | | | | | | le amplitı | ude 0. | 75 mm | l _ | | cal disconti | | | c | 0 | - |
| Shoc | k | | at 10 cycles for 3 direction. Acceleration 490 m/s ² duration of pulse 11 ms at 3 | | | | | | | _ | ②No damage, crack or looseness of parts. | | | | | | |
| | | | times for 3 directions. | | | | | | | | | | | | 0 | - | |
| | //DOA | INSENITAL OLIA | D40 | TEDI | | | | | | | | | | | | | <u> </u> |
| | Heat | IMENTAL CHA | | | | | idity 00 t | to 05 | % 06 k | I (1)Ca | ntoot vo | oiotonoo: | 20 m ∩ M/ | \ <u>\</u> | | 1 | |
| • | | | Exposed at 40 ± 2 °C , humidity 90 to 95 %, 96 h. (After leaving the room temperature for 1 to 2h.) | | | | | | | 1.7 | ①Contact resistance: $30 \text{ m}\Omega$ MAX. ②Insulation resistance: $500\text{M}\Omega$ MIN. | | | | | 0 | - |
| | | | | | | | | | | 3Nc | ③No damage, crack or looseness of parts. | | | | | | |
| Rema | | de the temperature | rising | by curr | ent | | | | | | | | | | | | |
| Note | 2: No c | ondensing | _ | - | | | | | | | | | | | | | |
| Note | | y to the condition o idity range is applied | _ | | _ | | - | | tore p | cb on boa | ard, afte | r pcb board | l , operatır | ng temp | eratu | e and | |
| | | | | | | | | | | | | | | | | | |
| | | | | | | | | | | | | | | | | | |
| | | | | | | | | DRAW | 'N | DESIG | GNED | CHECKE | D AP | PROVE | ρŢ | RELEA | SED |
| | | | | | | | | | | | | | . . | | | EN | G |
| | | | | | | | J | .S Cŀ | Ю | J.S (| СНО | S.M.LI | м 8 | S.M.LIM | - 1/ | 2023.0 | $\overline{}$ |
| | | | | | 21.05.14 | | | 21.0 | 21.05.14 21.05.14 21 | | | 1.05.14 | | | | | |
| | | ise specified, refer to | | | 01:5: | 105 == | OT 0 1 | 0 ADD: 10 AD: T | | | | | | | | | |
| NOT | E Q:1: | QUALIFICATION 1 | IESI | AI: AS | SUKAN | NGE IE | SI U: A | rrLI(| ARLE | IESI | P/ | ART NO. | | | | | |
| | HIRC | SE KOREA CO | "LTD. | D. SPECIFICATION SHEET | | | | | ĒΤ | DF51K-6P-2H(800) | | | | | | | |
| CODE | NO.(OL | D) | | DRAWIN | IG NO. | | | | CODE | NO. | | | 652-00 | | | | 1/ |
| CL | | | | | ELC | 4-633 | 490 | | | | | <u> </u> | JUUZ-00 | 10-0- | 500 | | / 2 |

| Rapid Change of | Temperature -55 °C → +105 °C | ①Contact resistance: 30 mΩ MAX. | | |
|-------------------------|---|--|---|---|
| Temperature | Time 30min → 30min | ②Insulation resistance: 1,000M Ω MIN. | 0 | - |
| | Under 5 Cycles. | ③No damage, crack or looseness of parts. | | |
| | (The transferring time of the tank is 2 to 3 MIN) | | | |
| | (After leaving the room temperature for 1 to 2h.) | | | |
| Dry Heat | Exposed at 105±2 °C, 96h | ①Contact resistance: 30 mΩ MAX. | | |
| | | ②Insulation resistance: 1,000M Ω MIN. | 0 | - |
| | | ③No damage, crack or looseness of parts. | | |
| Cold | Exposed at -55±3 °C, 96h | ①Contact resistance: 30 mΩ MAX. | | |
| | | ②Insulation resistance: 1,000M Ω MIN. | 0 | - |
| | | ③No damage, crack or looseness of parts. | | |
| Resistance To Soldering | Reflow time | No deformation of case of excessive looseness | | |
| Heat | Number of reflow cycles : 2cycles MAX | of the terminals. | 0 | |
| | Duration above 220°C, 60sec. MAX. | | " | - |
| | Peak temperature : 250°C 10sec. MAX | | | |
| Solderability | Soldering temperature: 245 °C | New uniform coating of solder shall cover | | |
| | Duration of immersion :soldering, for 5 sec. | minimum of 95 % of the surface Being | 0 | - |
| | | immersed. | | |
| Recommended | REFLOW TEMPERATURE PROFILE USING LEAD-FREE SOLDER PASTE (RE | EEDENCE) | | |
| Temperature Profile | NEI EOW TEHERATORE PROFILE OSING LEAD-FREE SOLDER FASTE INE | I LIVENCE/ | | |
| | t(°C) 10s MAX | | | |
| | 250 NUMBER | R OF REFLOW CYCLES 2CYCLES MAX. | | |
| | | MPERATURE IS MEASURED IN THE TERMINAL LEAD PART. | | |
| | 180 | | | |
| | 150+ | NAL FACTORS, SUCH AS SOLDER PASTE TYPE, | | |
| | / 🗸 🔻 | ZE AND OTHER MOUNTED COMPONENTS COULD AFFECT | | |
| | 100 / | OFILES. THEREFORE, A THOROUGH EVALUATION OF NG CONDITION IS REQUIRED PRIOR TO PRODUCTION. | | |
| | L/ | NO CONDITION IS REQUIRED FRIOR TO PRODUCTION. | | |
| | V | | | |
| | (\$) | | | |
| | (5) | | | |
| | 1 | | | |

| HIROSE KOREA CO.,LTD. SPECIFICATION SHEET PART NO. DF51K-6P-2H(800) | |
|--|-----|
| | |
| CODE NO.(OLD) DRAWING NO. CDE NO. CL 6652-0075-8-800 | 2/2 |